



## INFORMATION DISCLOSURE STATEMENT BY APPLICANT

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Application Number	10/602,147
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Filing Date	6/24/2003
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First Named Inventor	Yao, et al.
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Art Unit	2812
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Examiner Name	Stevenson, Andre C.
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Attorney Docket Number	TSM02-1098
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## U.S. PATENT DOCUMENTS

[illegible]

## FOREIGN PATENT DOCUMENTS

Examiner Initials <sup>a</sup>	Cite No. <sup>1</sup>	Foreign Patent Document	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	T <sup>o</sup>
		Country Code <sup>3</sup> - Number <sup>4</sup> - Kind Code <sup>5</sup> (if known)				

### NON PATENT LITERATURE DOCUMENTS

Examiner Initials*	Cite No.	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T <sup>2</sup>
RS	1	OGAWA, E.T., et al., "Stress-Induced Voiding under Vias Connected to Wide Cu Metal Leads," IEEE International Reliability Physics Symposium Proceedings, 40 <sup>th</sup> Annual, 2002, pp. 312-321.	

Examiner Signature	<i>Andie C. Duvette</i>	Date Considered	09/14/04
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